



# N-Channel 60-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
60	$0.0035 \text{ at V}_{GS} = 10 \text{ V}$	4408		
00	0.005 at V <sub>GS</sub> = 4.5 V	110 <sup>a</sup>		

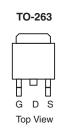
#### **FEATURES**

- TrenchFET® Power MOSFETS
- New Low Thermal Resistance Package



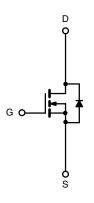
### **APPLICATIONS**

- High Current
- DC/DC Converters



Ordering Information: SUM110N06-04L

SUM110N06-04L (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T <sub>C</sub> = 25 °C, unless o	therwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	_ v
Continuous Drain Current (T <sub>.1</sub> = 175 °C)	T <sub>C</sub> = 25 °C	-	110 <sup>a</sup>	
Continuous Diain Current (1) = 175 C)	T <sub>C</sub> = 125 °C	I <sub>D</sub>	110 <sup>a</sup>	Α
Pulsed Drain Current		I <sub>DM</sub>	440	7 ^
Avalanche Current		I <sub>AR</sub>	75	
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	280	mJ
b	T <sub>C</sub> = 25 °C	В	437.5 <sup>c</sup>	14/
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C <sup>d</sup>	P <sub>D</sub>	3.75	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount <sup>d</sup>	R <sub>thJA</sub>	40	°C/W
Junction-to-Case (Drain)		$R_{thJC}$	0.4	] 5/**

#### Notes:

- a. Package limited.
- b. Duty cycle  $\leq$  1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply.

# SUM110N06-04L

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	<u>'</u>				<u> </u>		
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			1	μА	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50		
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.0028	0.0035		
	_	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		0.004	0.005	Ω	
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C			0.0058		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C			0.0088		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$	30			S	
Dynamic <sup>b</sup>	•						
Input Capacitance	C <sub>iss</sub>			7500		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1050			
Reverse Transfer Capacitance	C <sub>rss</sub>			700			
Total Gate Charge <sup>c</sup>	$Q_g$			150	220	nC	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 110 \text{ A}$		25			
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			45			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	30		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 0.4 $\Omega$		135	200	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		80	120		
Fall Time <sup>c</sup>	t <sub>f</sub>			150	220	20	
Source-Drain Diode Ratings and Cha	aracteristics	C <sub>C</sub> = 25 °C <sup>b</sup>		·	<u>l</u>		
Continuous Current	Is	ls ls			110	А	
Pulsed Current	I <sub>SM</sub>				440		
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 110 A, V <sub>GS</sub> = 0 V		1.1	1.4	V	
Reverse Recovery Time	t <sub>rr</sub>			75	120	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 110 A, di/dt = 100 A/μs		2.5	5	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.09	0.25	μC	

#### Notes:

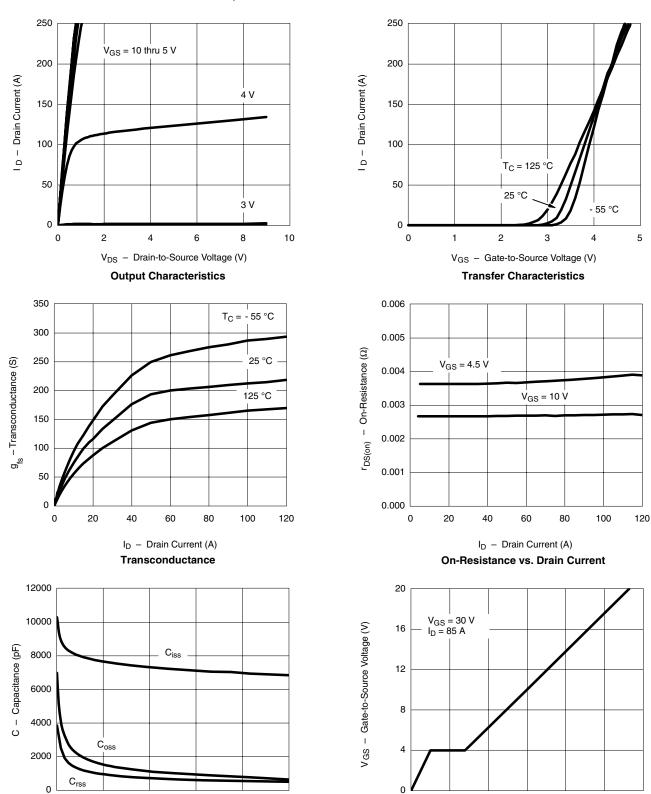
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0

50

100

Q<sub>g</sub> - Total Gate Charge (nC)

**Gate Charge** 

0

12

V<sub>DS</sub> - Drain-to-Source Voltage (V)

Capacitance

250

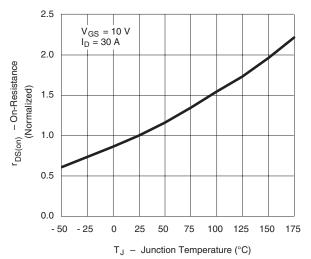
200

300

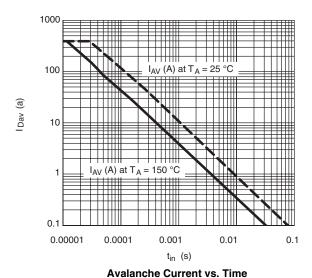
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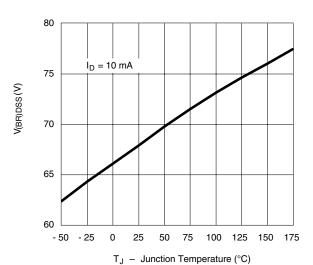
# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

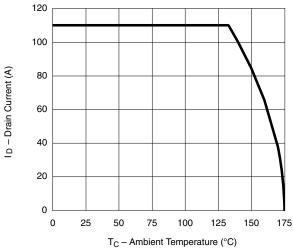


Drain Source Breakdown vs. Junction Temperature

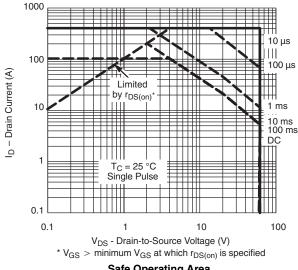


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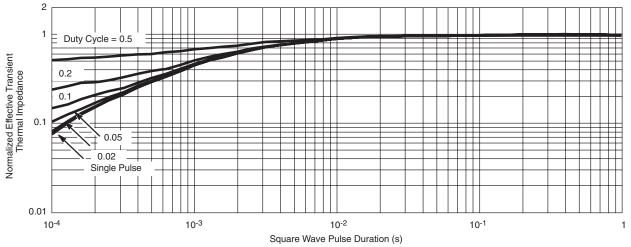
## THERMAL RATINGS











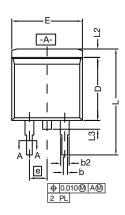
Normalized Thermal Transient Impedance, Junction-to-Case

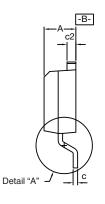
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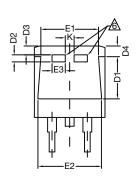
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# TO-263 (D<sup>2</sup>PAK): 3-LEAD

### **VERSION 1: FACILITY CODE = T**

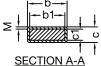








**DETAIL A (ROTATED 90°)** 



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## **Notes**

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

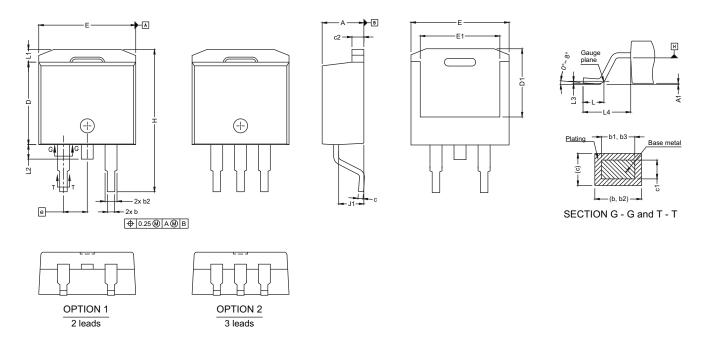
		INC	HES	MILLIMETERS		
	DIM.	MIN.	MAX.	MIN.	MAX.	
	Α	0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
Ci	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1_	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
K		0.045	0.055	1.143	1.397	
L		0.575	0.625 14.605		15.875	
L1		L1 0.090		2.286	2.794	
	L2 0.04		0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010	BSC	0.254	BSC	
	М	-	0.002	-	0.050	



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## **VERSION 2: FACILITY CODE = N**



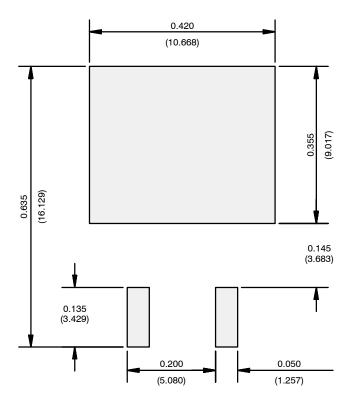
DIM.	MIN.	MAX.		
A	4.36	4.56		
A1	0 0.25			
b	0.70	0.90		
b1	0.51	0.89		
b2	1.20	1.46		
b3	1.17	1.37		
С	0.38	0.694		
c1	0.38	0.534		
c2	1.19	1.34		
D	8.60	9.00		
D1	6.9	7.5		
E	10.15	10.55		
E1	8.1	8.7		
е	2.54	BSC		
Н	15.0	15.6		
L	1.9	2.5		
L1	-	1.65		
L2	-	1.78		
L3	0.25 typ.			
L4	4.78	5.28		
J1	2.56	2.56 2.96		

DWG: 5843





# RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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